

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
WENYU LIU	07/19/2018
HONGQIANG HAN	07/19/2018
HONGWEN YANG	07/19/2018
LIZHOU LI	07/19/2018
YOUWEI PAN	07/19/2018
RECEIVING PARTY DATA	
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Street Address:	SECTIONS F AND G, LEVEL 1, BUILDING 15
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City:	SHANGHAI
State/Country:	CHINA
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16059221
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NAME OF SUBMITTER:	SALVATORE ANASTASI
SIGNATURE:	/Salvatore Anastasi/
DATE SIGNED:	08/09/2018
Total Attachments: 2	

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26-July-2018

Our Ref.: P195998.US.01

Client Ref.: DD-03392 US

Attorney Docket No.: 21334-2681

COMBINED DECLARATION AND ASSIGNMENT

As a below-named inventor, I hereby declare that:

this declaration is directed to inventions and improvements disclosed in:

☒ the attached application, or☐ United States application or PCT international application number _____
filed on _____, entitled Clamping Mechanism For Heat Sink And Electronic
Device Assembly Including The Same ("the APPLICATION")

The APPLICATION was made or authorized to be made by me;

I believe that I am the original inventor or an original joint inventor of a claimed invention in the APPLICATION;

I have reviewed and understand the contents of the APPLICATION, including the claims, and I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37.C.F.R 1.56; AND

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

As a below named and signing inventor, acknowledging that I have assigned or have obligations to assign the APPLICATION to:

Tyco Electronics (Shanghai) Co. Ltd. ("ASSIGNEE"), a corporation organized and existing under and by virtue of the laws of *China* having its principal place of business at *Sections F and G Level 1 Building 15 No. 999 Yinglun Road, China (Shanghai) Pilot Free Trade Zone, Shanghai, China,*

for a valuable consideration, the receipt of which is hereby acknowledged, I do hereby sell, assign, transfer and set over unto the said ASSIGNEE, its successors and assigns, my full and entire right, title and interest in and to the APPLICATION, the inventions and improvements disclosed in the APPLICATION, all divisions, continuations, continuations-in-part, or renewals thereof, all Letters Patent to be granted and issued therefor, not only for, to and in the rights under the International Convention, and all reissues, re-examinations, renewals or extensions thereof, and I hereby authorize and request the United States Patent and Trademark Office and/or other patent office(s) to issue said Letters Patent to said ASSIGNEE, its successors and assigns, in accordance with this assignment

Legal Name	Signature	Date
LIU, WenYu	LIU, WenYu	2018/07/19
HAN, Hongqiang	HAN, HONGQIANG	2018/07/19
YANG, Hongwen	YANG, Hongwen	2018/07/19
LI, Lizhou	LI Lizhou	2018/07/19

US – United States

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PAN, Youwei	PAN, Youwei	2018/07/19
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